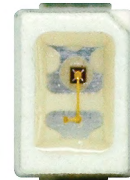


Mini DomiLED

Synonymous with function and performance, the Mini DomiLED series is perfectly suited for a variety of cross-industrial applications due to its small package outline, durability and superior brightness.



Features:

- > High brightness surface mount LED.
- > 120° viewing angle.
- > Small package outline (LxWxH) of 2.0 x 1.4 x 1.3mm.
- > Qualified according to JEDEC moisture sensitivity Level 2.
- > Compatible to IR reflow soldering.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q101.
- > Passed Corrosion Resistant Test. *Appx. 4.1*



Applications:

- > Automotive: interior applications, eg: switches, telematics, climate control system, dashboard, etc.
- > Backlighting: button, LCD display



Optical Characteristics at Tj=25°C

Part Ordering Number	Color	Viewing Angle°	Luminous Intensity @ IF = 30mA IV (mcd) <i>Appx. 1.1</i>		
			Min.	Typ.	Max.
DNP-SJS-NP2-1-I3	Pure Green, 560nm	120	28.5	45.0	71.5

Electrical Characteristics at Tj=25°C

Part Number	Min. (V)	Vf @ If = 30mA <i>Appx. 3.1</i>			Vr @ Ir = 10uA <i>Appx. 6.1</i>
		Typ. (V)	Max. (V)	Min. (V)	
DNP-SJS	1.9	2.1	2.4	12	

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	40	mA
Peak pulse current; (tp ≤ 10µs, Duty cycle = 0.005)	500	mA
Reverse voltage <i>Appx. 6.1</i>	12	V
ESD threshold (HBM)	2000	V
LED junction temperature	125	°C
Operating temperature	-40 ... +100	°C
Storage temperature	-40 ... +100	°C
Power dissipation (at room temperature)	120	mW
Thermal resistance (Rated current = 30mA, Ts = 25 °C)		
- Real Thermal Resistance	580	K/W
Junction / ambient, Rth JA real	330	K/W
Junction / solder point, Rth JS real		
- Electrical Thermal Resistance		
Junction / ambient, Rth JA el	430	K/W
Junction / solder point, Rth JS el	230	K/W
(Mounting on FR4 PCB, pad size ≥ 16 mm2 per pad)		

Wavelength Grouping at Tj=25°C

Color	Group	Wavelength distribution(nm) <i>Appx. 2.2</i>
DNP; Pure Green	Full	552.5 - 564.5
	W	552.5 - 555.5
	X	555.5 - 558.5
	Y	558.5 - 561.5
	Z	561.5 - 564.5

Luminous Intensity Group at Tj=25°C

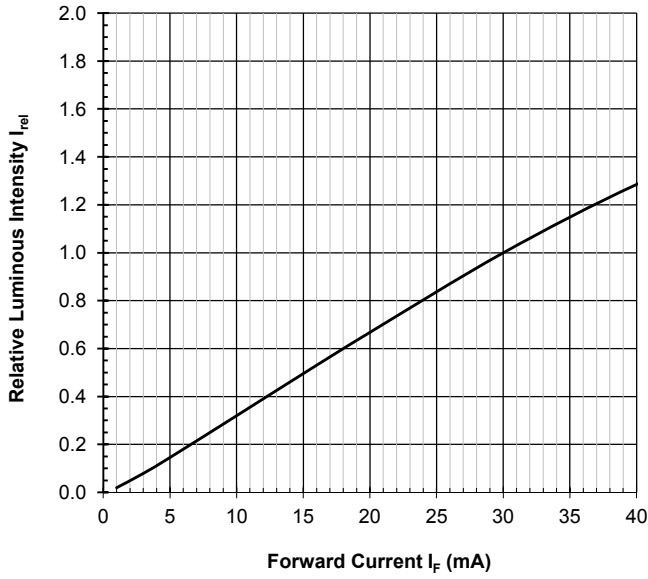
Brightness Group	Luminous Intensity <i>Appx. 1.1</i> IV (mcd)
N1	28.5...35.5
N2	35.5...45.0
P1	45.0...56.0
P2	56.0...71.5

Vf Binning (Optional)

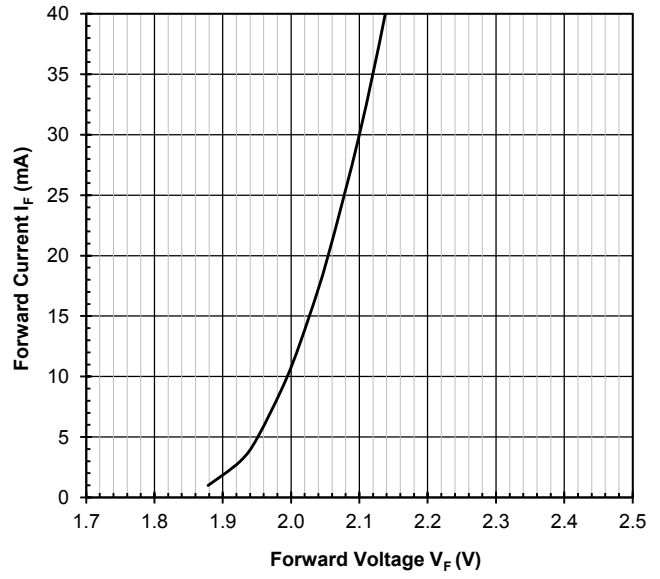
Vf @ If = 30mA	Forward Voltage (V) <i>Appx. 3.1</i>
V03	1.80 ... 1.95
V04	1.95 ... 2.10
V05	2.10 ... 2.25
V06	2.25 ... 2.40

Please consult sales and marketing for special part number to incorporate Vf binning.

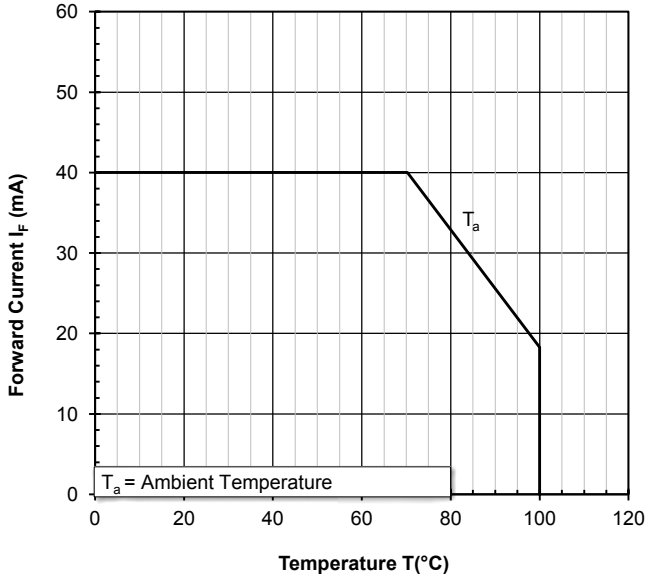
Relative Luminous Intensity Vs Forward Current
 $I_v/I_v(30\text{mA}) = f(I_F); T_j = 25^\circ\text{C}$



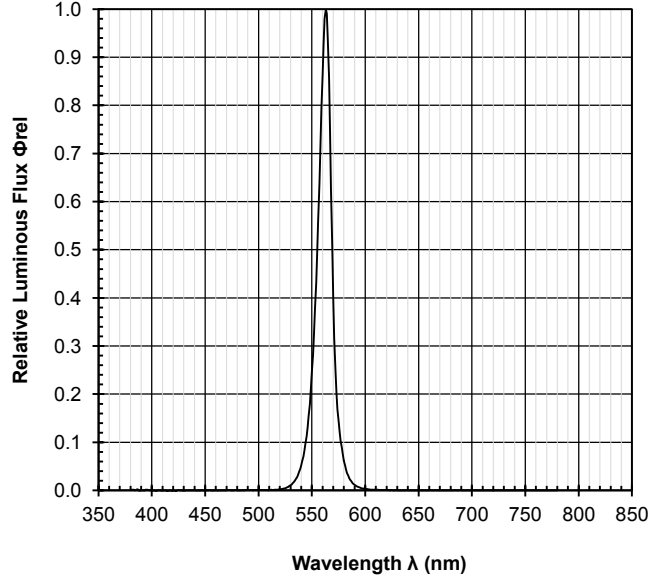
Forward Current Vs Forward Voltage
 $I_F = f(V_F); T_j = 25^\circ\text{C}$



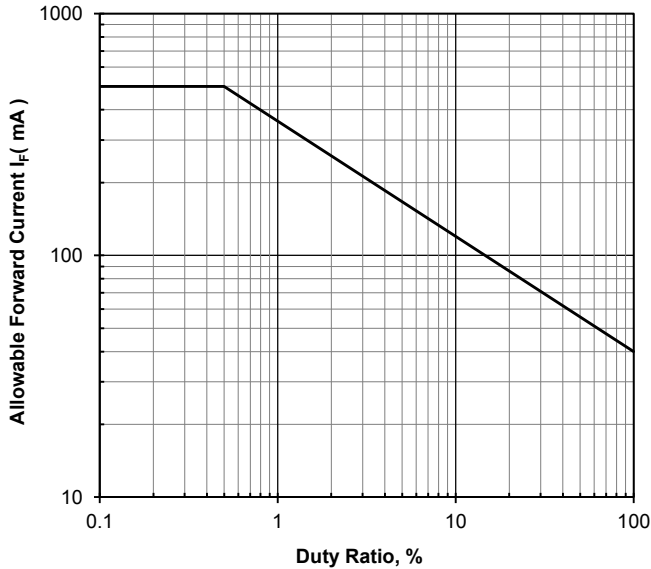
Maximum Current Vs Temperature
 $I_F = f(T)$



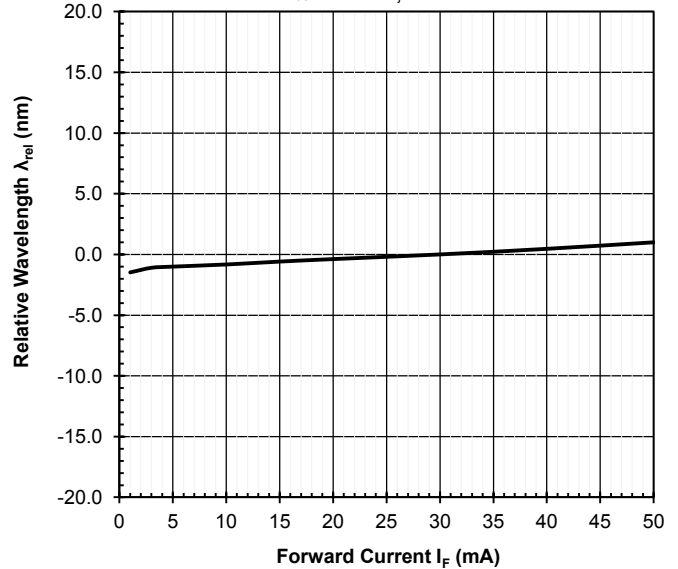
Relative Spectral Emission
 $I_{rel} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 30\text{mA}$



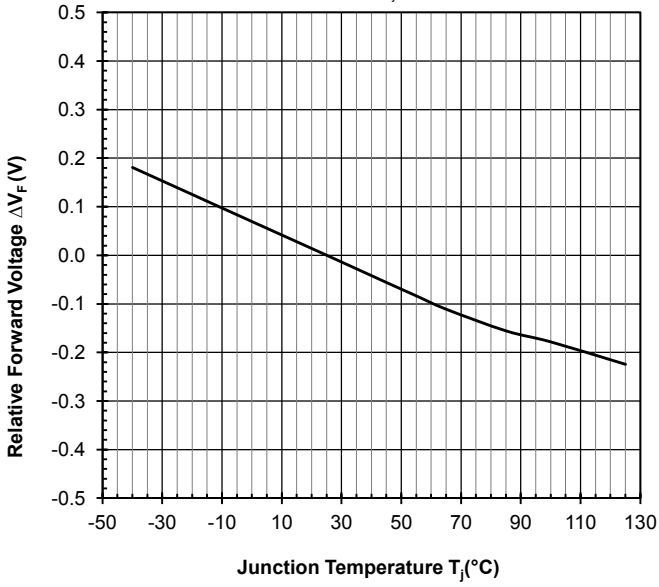
Allowable Forward Current Vs Duty Ratio
 $(t_p \leq 10\mu\text{s}, D = 0.005)$



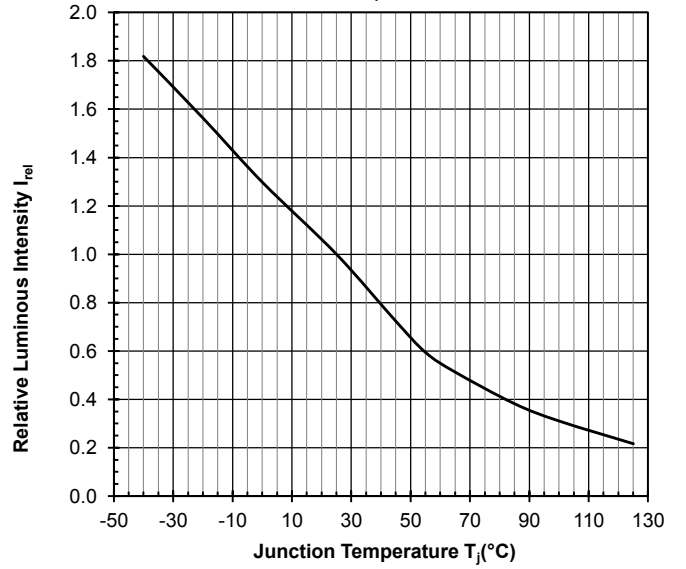
Relative Wavelength Shift Vs Forward Current
 $\lambda_{dom} = f(I_F); T_j = 25^\circ\text{C}$



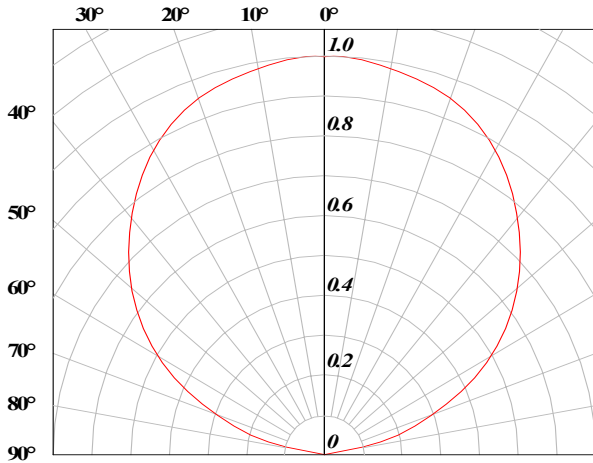
Relative Forward Voltage Vs Junction Temperature
 $\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 30\text{mA}$



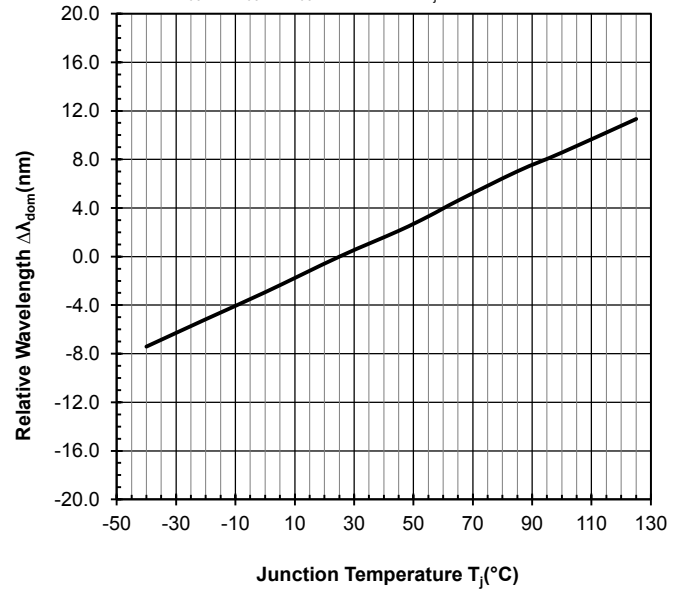
Relative Luminous Intensity Vs Junction Temperature
 $I_v/I_v(25^\circ\text{C}) = f(T_j); I_F = 30\text{mA}$



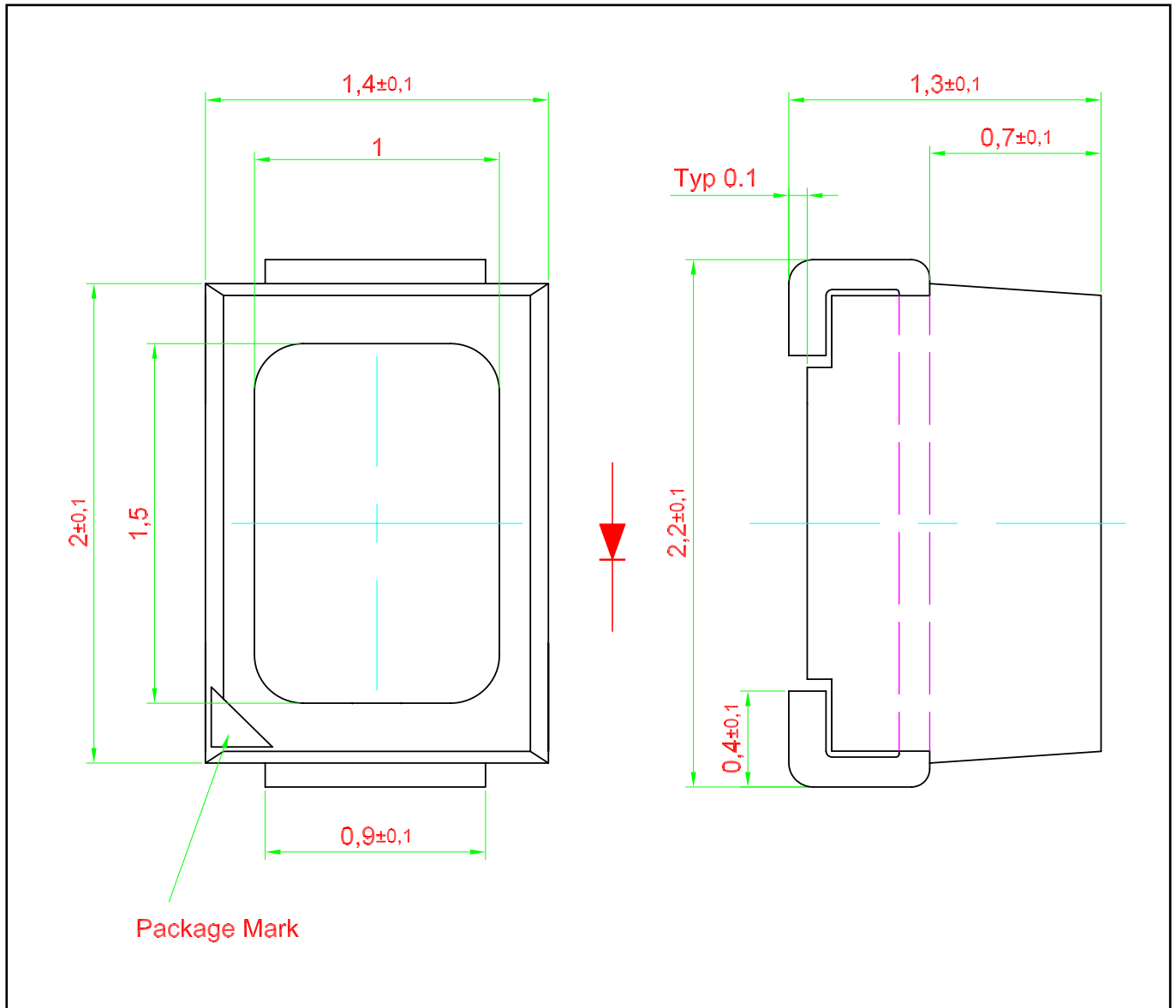
Radiation Pattern



Relative Wavelength Vs Junction Temperature
 $\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom}(25^\circ\text{C}) = f(T_j); I_F = 30\text{mA}$



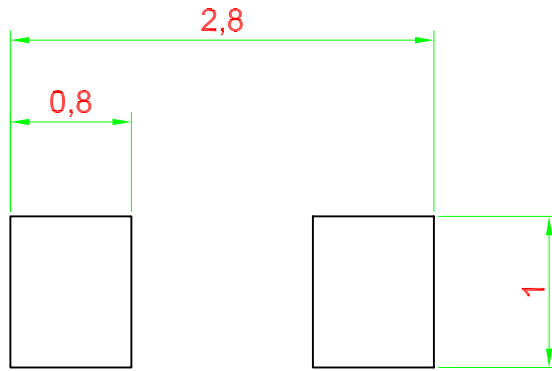
Mini DomiLED • AllInGaP : DNP-SJS-NP2-1-I3 Package Outlines



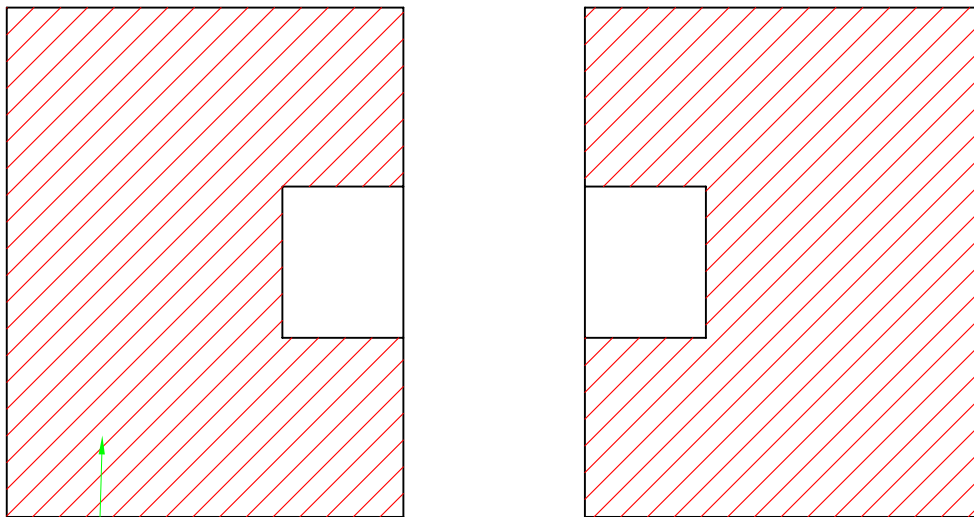
Material

Material	
Lead-frame	Cu Alloy With Ag Plating
Package	High Temperature Resistant Plastic, PPA
Encapsulant	Epoxy
Soldering Leads	Sn-Sn Plating

Recommended Solder Pad



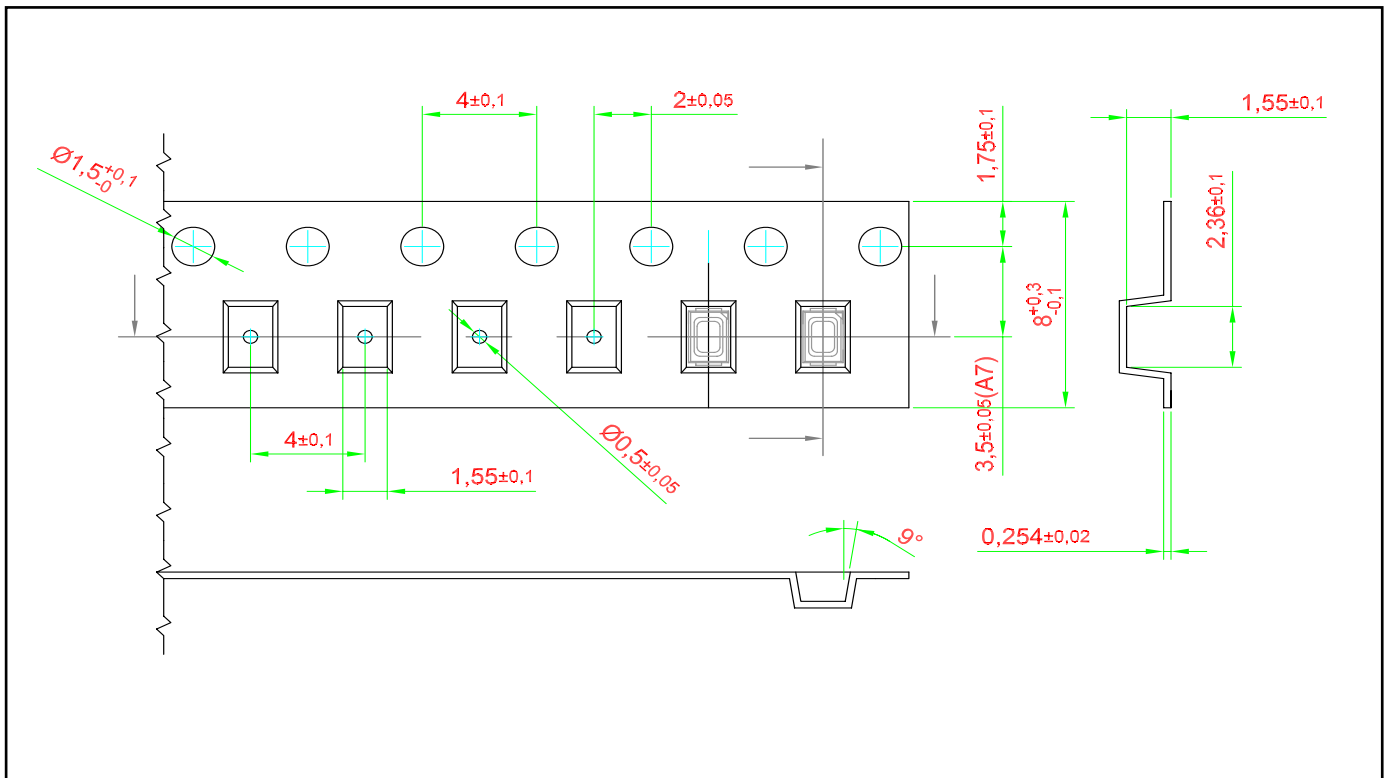
Improved Design For Better Heat Dissipation



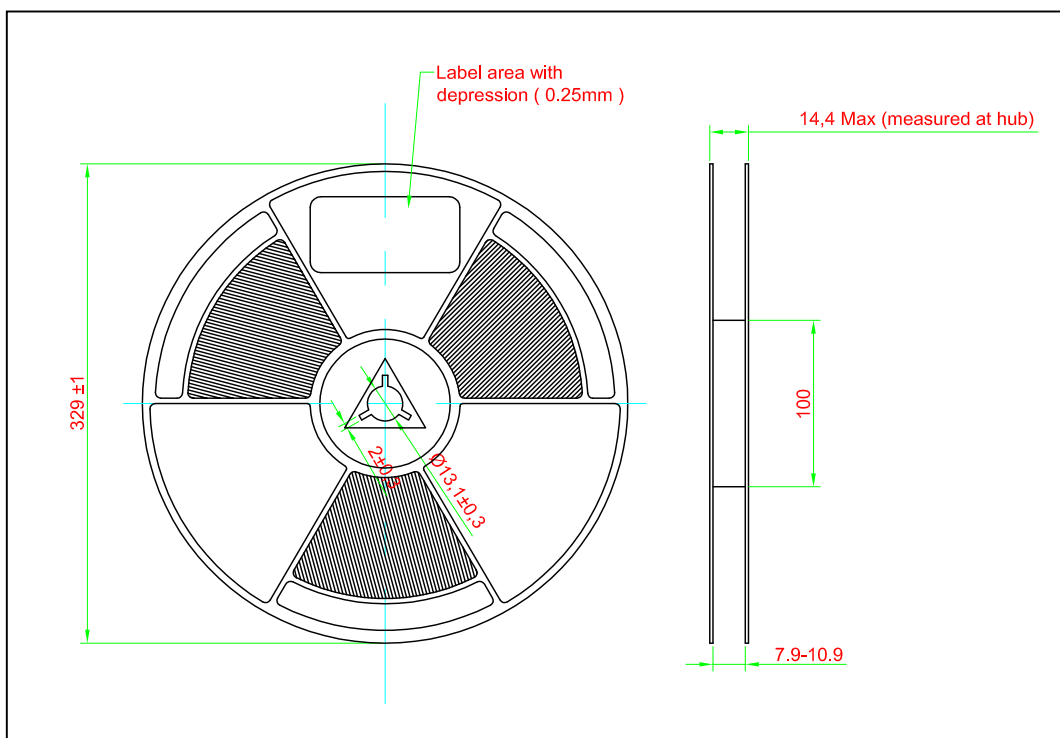
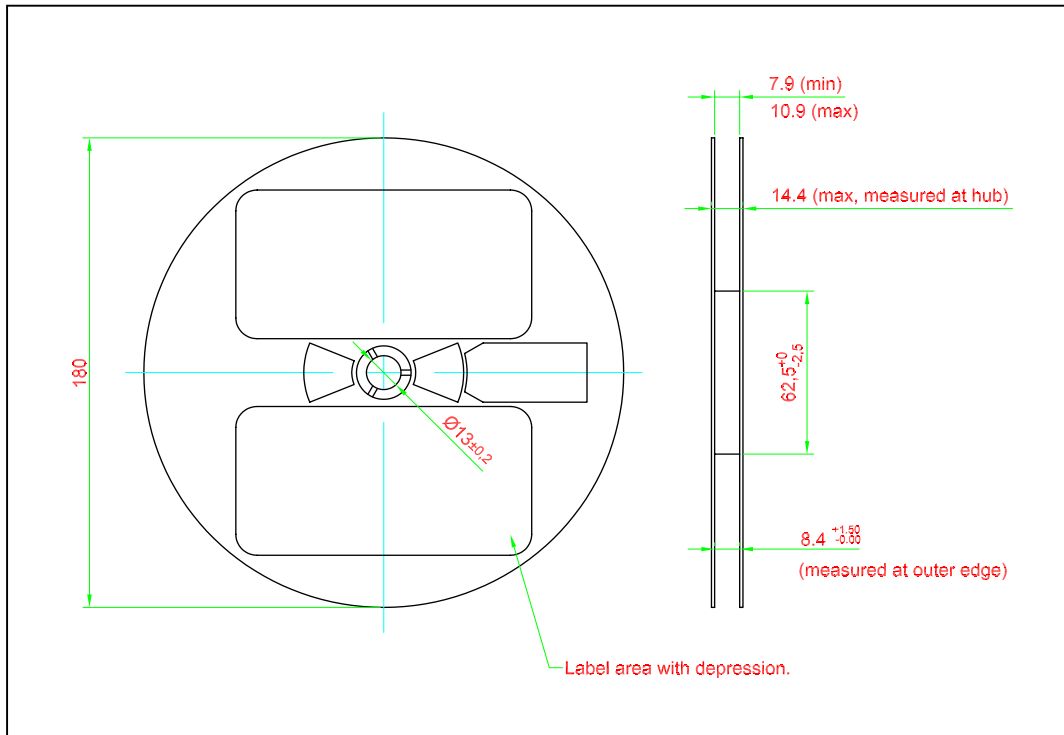
Additional Cu area for improved heat dissipation, > 16mm sq.

 Solder resist.

Taping and orientation

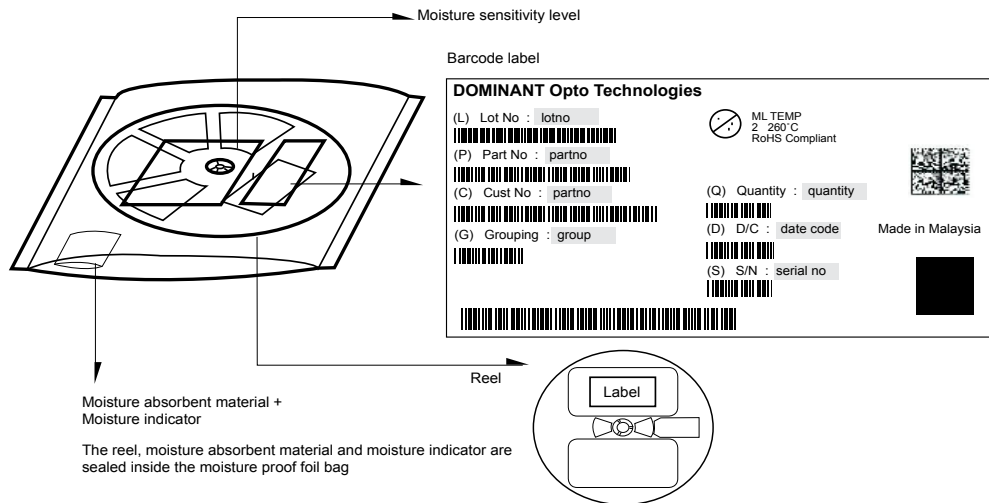


Packaging Specification

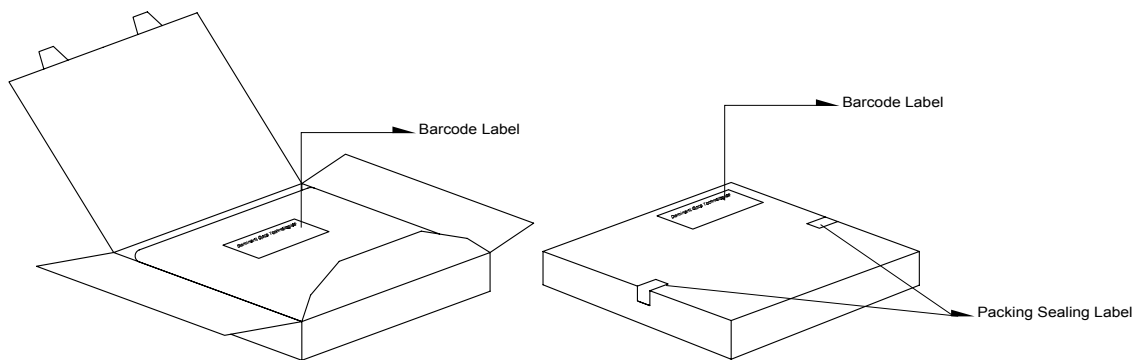


	Reel Diameter (mm)	Quantity (pcs)	Partno
Standard Packing	180	3000	DNP-SJS-xxx-x-x
Optional Packing	329	10000	DNP-SJS-xxx-x-x-J

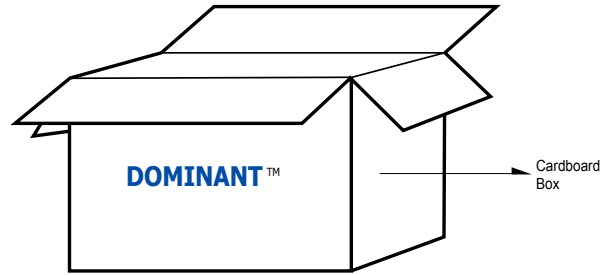
Packaging Specification



Quantity per bag (pcs)	Average 1pc Mini DomiLED (gram)	1 completed bag (gram)
3000	0.007	200 ± 10
10000	0.007	550 ± 10

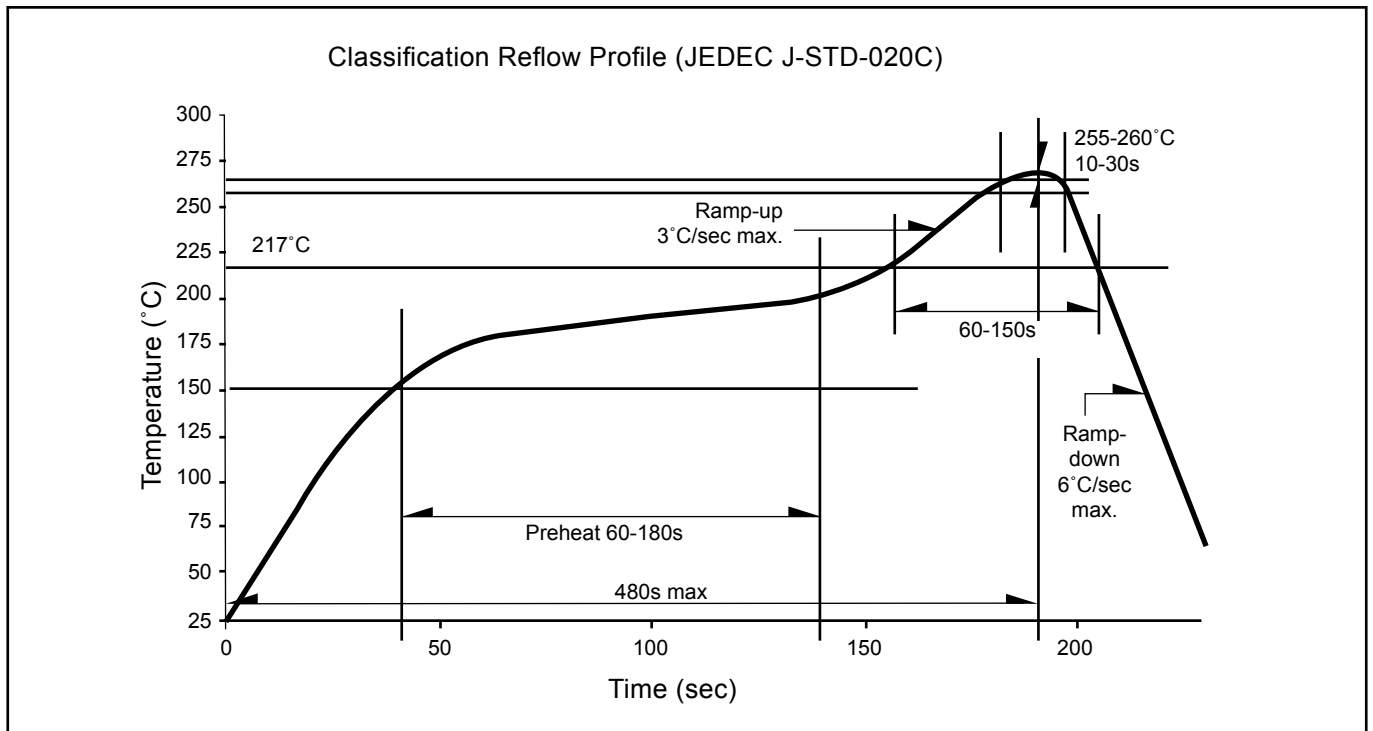


Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 16
329	345 x 345 x 16



Reel Diameter (mm)	Cardboard Box Size	Dimensions (mm)	Empty Box Weight (kg)	Reel / Box
180	Super Small	325 x 225 x 190	0.38	9 reels MAX
180	Small	325 x 225 x 280	0.54	15 reels MAX
180	Medium	570 x 440 x 230	1.46	60 reels MAX
180	Large	570 x 440 x 460	1.92	120 reels MAX
329	Medium	373 x 373 x 285	1.02	13 reels MAX
329	Large	580 x 373 x 405	1.50	30 reels MAX

Recommended Pb-free Soldering Profile



Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specified in mm.

6) **Reverse Voltage:**

- 6.1 Not designed for reverse operation. Continuous reverse voltage can cause migration and LED damage.

Revision History

Page	Subjects	Date of Modification
-	Initial Release	04 Mar 2008
4	Update Relative Luminous Intensity Vs Forward Current Graph	06 Oct 2008
7	Update carrier tape drawing	10 Aug 2010
2	Update Electrical Characteristics	19 Nov 2010
4	Typo error in relative luminous intensity Vs forward current	19 Apr 2011
3	Add Characteristics	22 Feb 2012
1, 2, 3, 4, 5, 9, 10, 11, 13	Updates Features Update Absolute Maximum Ratings Remove Characteristics Add Vf Binning Option Update All Graphs in New Format Update Packaging Specification Add Appendix	30 Oct 2019

NOTE

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About Us

DOMINANT Opto Technologies is a dynamic company that is amongst the world's leading automotive LED manufacturers. With an extensive industry experience and relentless pursuit of innovation, DOMINANT's state-of-art manufacturing and development capabilities have become a trusted and reliable brand across the globe. More information about DOMINANT Opto Technologies, an IATF 16949 and ISO 14001 certified company, can be found under <http://www.dominant-semi.com>.

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